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RFHA1003

30MHz TO 512MHz, 9W GaN WIDEBAND POWER AMPLIFIER

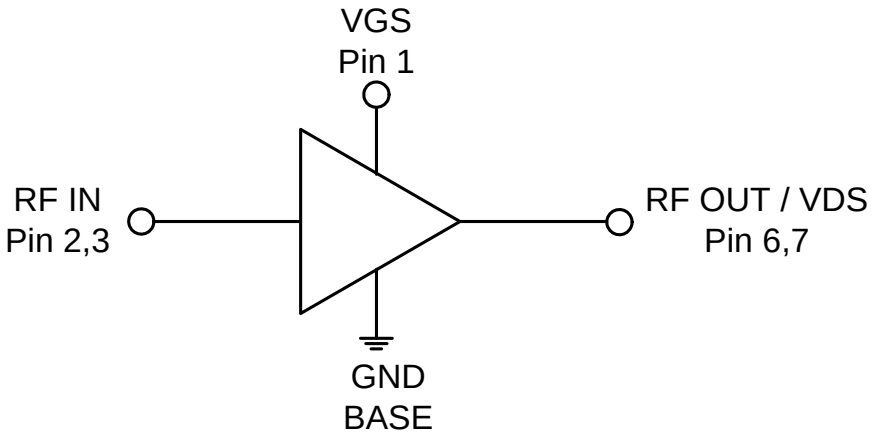
Package: AlN Leadless Chip Carrier / SO8

Features

- Advanced GaN HEMT Technology
- Output Power of 9W
- Advanced Heat-Sink Technology
- 30MHz to 512MHz Instantaneous Bandwidth
- Input Internally Matched to 50Ω
- 28V Operation Typical Performance
  - Output Power 39.5dBm
  - Gain 19dB
  - Power Added Efficiency 70%
- -40°C to 85°C Operating Temperature
- Large Signal Models Available

Applications

- Pre-Driver for Multiband Wireless Infrastructure Transmitters
- Class AB Operation for Public Mobile Radio
- Power Amplifier Stage for Commercial Wireless Infrastructure
- General Purpose Tx Amplification
- Test Instrumentation
- Civilian and Military Radar



Functional Block Diagram

Product Description

The RFHA1003 is a wideband Power Amplifier designed for CW and pulsed applications such as wireless infrastructure, RADAR, two way radios and general purpose amplification. Using an advanced high power density Gallium Nitride (GaN) semiconductor process, these high-performance amplifiers achieve high efficiency, flat gain, and large instantaneous bandwidth in a single amplifier design. The RFHA1003 is an input matched GaN transistor packaged in an air cavity ceramic package which provides excellent thermal stability through the use of advanced heat sink and power dissipation technologies. Ease of integration is accomplished through the incorporation of optimized input matching network within the package that provides wideband gain and power performance in a single amplifier. An external output match offers the flexibility of further optimizing power and efficiency for any sub-band within the overall bandwidth.

Ordering Information

RFHA1003S2	2-Piece sample bag
RFHA1003SB	5-Piece bag
RFHA1003SQ	25-Piece bag
RFHA1003SR	100 Pieces on 7” short reel
RFHA1003TR7	750 Pieces on 7” reel
RFHA1003PCBA-410	Fully assembled evaluation board 30MHz to 512MHz; 28V operation

Optimum Technology Matching® Applied

☐ GaAs HBT	☐ SiGe BiCMOS	☐ GaAs pHEMT	☑ GaN HEMT
☐ GaAs MESFET	☐ Si BiCMOS	☐ Si CMOS	☐ BiFET HBT
☐ InGaP HBT	☐ SiGe HBT	☐ Si BJT	

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Absolute Maximum Ratings

Parameter	Rating	Unit
Drain Voltage (V_D)	150	V
Gate Voltage (V_G)	-8 to +2	V
Gate Current (I_G)	5	mA
Operational Voltage	32	V
RF- Input Power	27	dBm
Ruggedness (VSWR)	12:1	
Storage Temperature Range	-55 to +125	°C
Operating Temperature Range (T_L)	-40 to +85	°C
Operating Junction Temperature (T_J)	200	°C
Human Body Model	Class 1C	
MTTF (T_J < 200°C, 95% Confidence Limits)*	3 x 10^6	Hours
Thermal Resistance, R_{TH} (junction to case) measured at T_C = 85 °C, DC bias only	9.8	°C/W

Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

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RoHS (Restriction of Hazardous Substances): Compliant per EU Directive 2002/95/EC.

* MTTF - median time to failure for wear-out failure mode (30% I_{DSS} degradation) which is determined by the technology process reliability. Refer to product qualification report for FIT(random) failure rate.
Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page two.
Bias Conditions should also satisfy the following expression: $P_{DISS} < (T_J - T_C)/R_{TH}$ J - C and $T_C = T_{CASE}$

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Recommended Operating Conditions					
Drain Voltage (V_{DSQ})		28	32	V	
Gate Voltage (V_{GSQ})	-5	-3	-2	V	
Drain Bias Current		55		mA	
RF Input Power (P_{IN})			25	dBm	
Input Source VSWR			10:1		
RF Performance Characteristics					
Frequency Range	30		512	MHz	Small signal 3dB bandwidth
Linear Gain		19		dB	P_{OUT} = 30dBm, 100MHz
Power Gain		16		dB	P3DB, 100MHz
Gain Flatness		2		dB	P_{OUT} = 30dBm, 30MHz to 2500MHz
Gain Variation with Temperature		-0.02		dB/ °C	
Input Return Loss (S_{11})			-10	dB	
Output Power (P_{3dB})		39.5		dBm	30MHz to 512MHz
Power Added Efficiency (PAE)		70		%	30MHz to 512MHz

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Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
RF Functional Tests					[1], [2]
$V_{GS(Q)}$		-3.0		V	
Gain	18	18.5		dB	P_{IN} = 10dBm
Power Gain	14.3	15.5		dB	P_{IN} = 25dBm
Input Return Loss			-10	dB	
Output Power	39	39.5		dBm	
Power Added Efficiency (PAE)	60	70		%	

[1] Test Conditions: V_{DSQ} = 28V, I_{DQ} = 55mA, CW, f = 300MHz, T = 25°C.
[2] Performance in a standard tuned test fixture.

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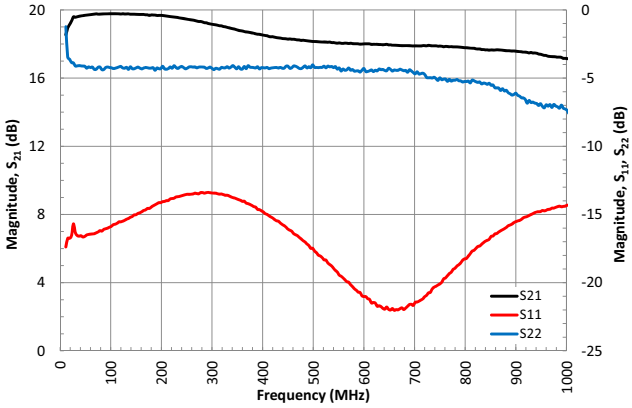
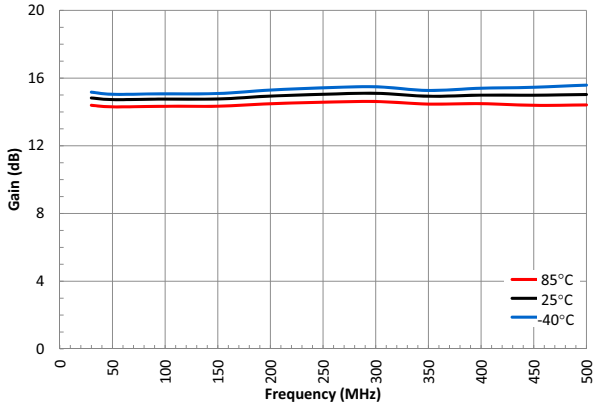
Typical Performance in Standard Fixed Tuned Test Fixture Matched for 30MHz to 512MHz (T = 25°C, unless noted)

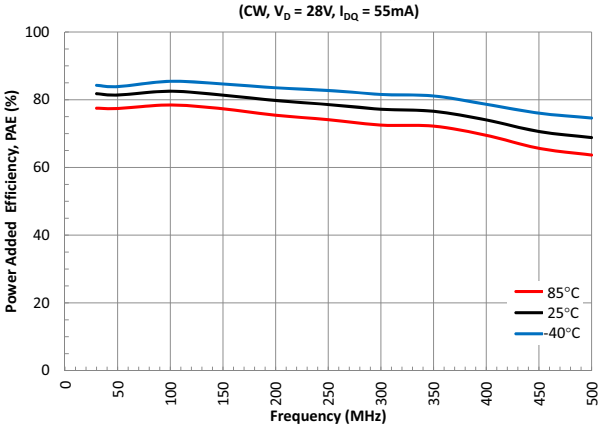
Small Signal s-parameters versus Frequency
(V_D = 28V, I_{DQ} = 55mA)



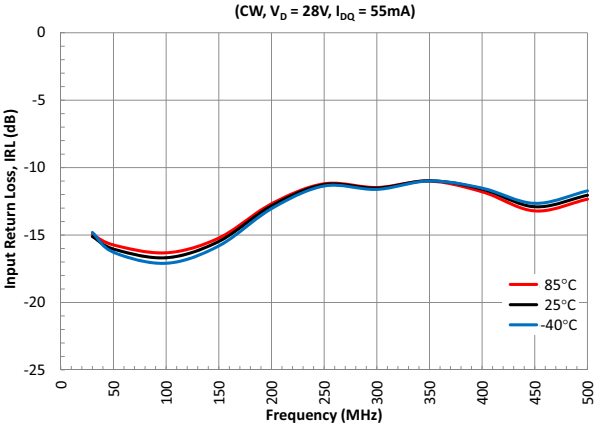
Gain versus Frequency, P_{IN} = 25dBm
(CW , V_D = 28V, I_{DQ} = 55mA)



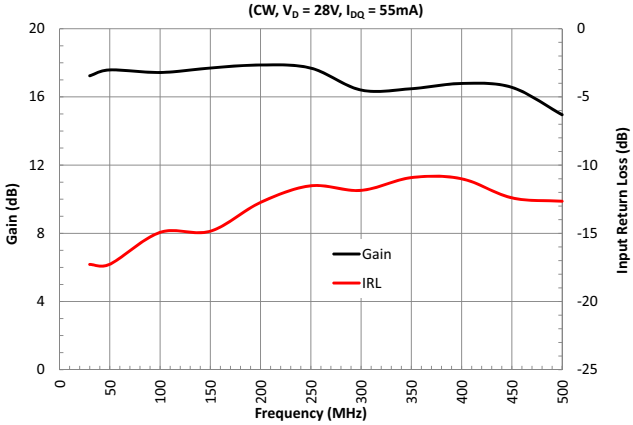
PAE versus Frequency, P_{IN} = 25dBm
(CW, V_D = 28V, I_{DQ} = 55mA)



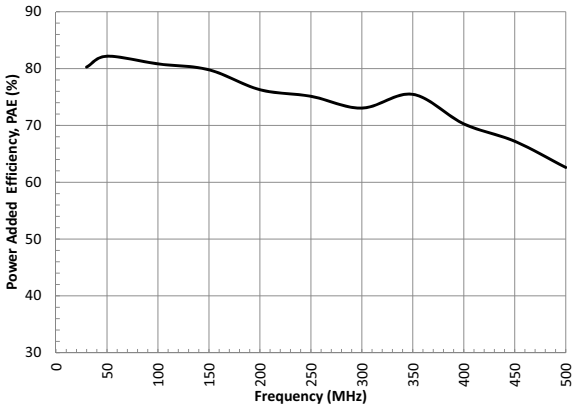
Input Return Loss versus Frequency, P_{IN} = 25dBm
(CW, V_D = 28V, I_{DQ} = 55mA)



Gain/IRL versus Frequency, P_{OUT} = 39.5dBm
(CW, V_D = 28V, I_{DQ} = 55mA)



PAE versus Frequency, P_{OUT} = 39.5dBm
(CW, V_D = 28V, I_{DQ} = 55mA)



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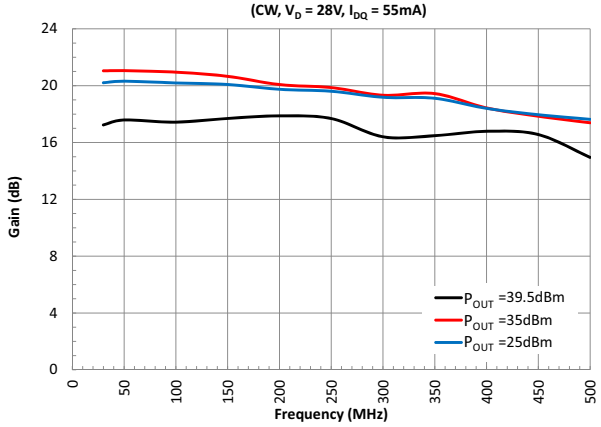
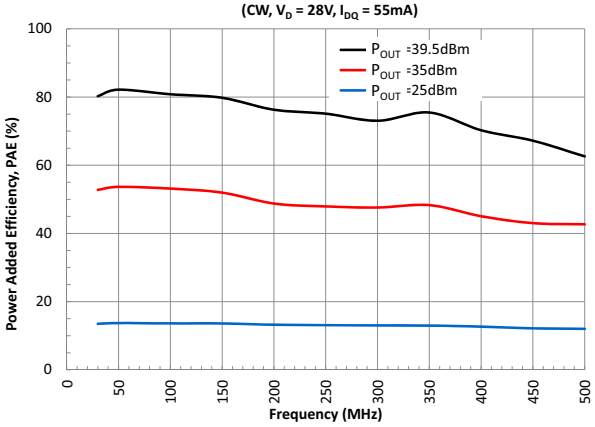
Typical Performance in standard fixed tuned test fixture matched for 30MHz to 512MHz (T = 25°C, unless noted)

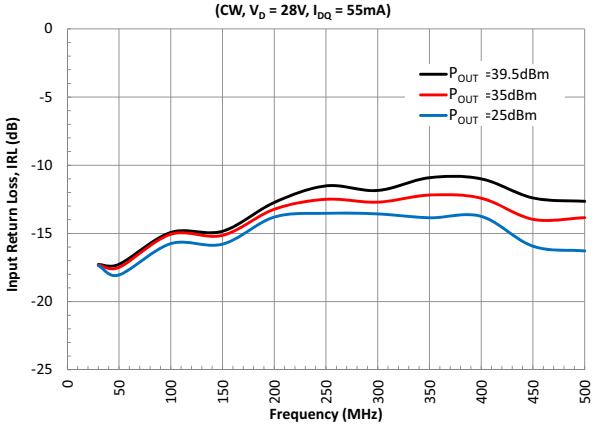
Gain versus Frequency
(CW, V_D = 28V, I_{DQ} = 55mA)



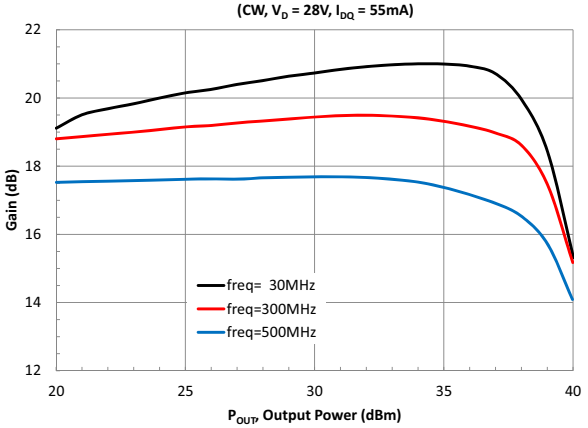
Power Added Efficiency versus Frequency
(CW, V_D = 28V, I_{DQ} = 55mA)



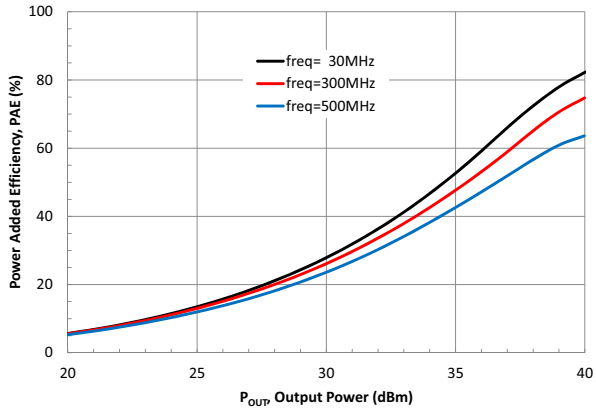
Input Return Loss versus Frequency
(CW, V_D = 28V, I_{DQ} = 55mA)



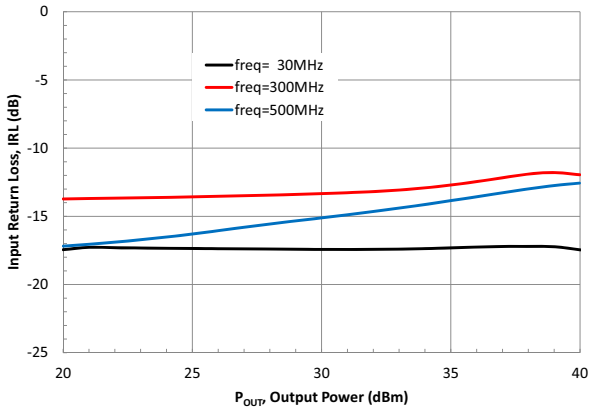
Gain versus Output Power
(CW, V_D = 28V, I_{DQ} = 55mA)



Power Added Efficiency versus Output Power
(CW, V_D = 28V, I_{DQ} = 55mA)

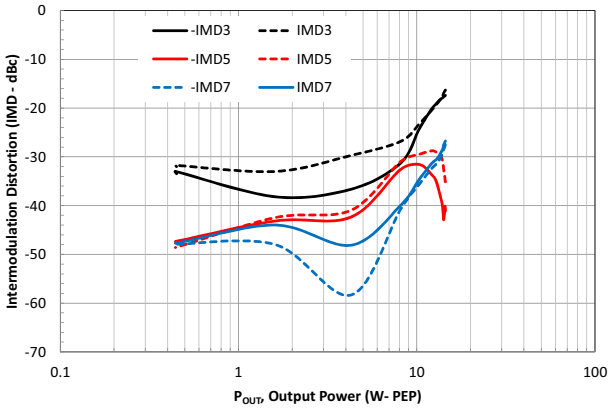


Input Return Loss versus Output Power
(CW, V_D = 28V, I_{DQ} = 55mA)

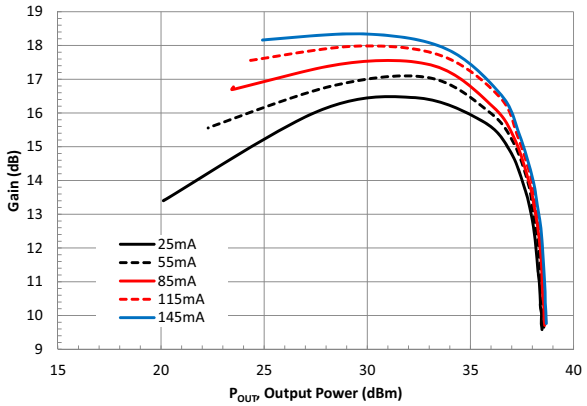


Typical Performance in Standard Fixed Tuned Test Fixture Matched for 30MHz to 512MHz (T = 25°C, unless noted)

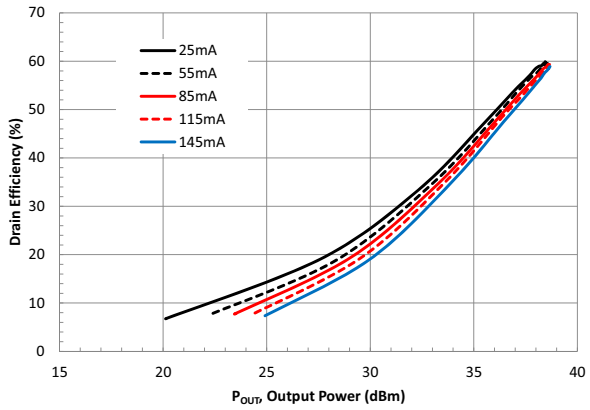
IMD versus Output Power
(V_D = 28V, I_{DQ} = 85mA, f1 = 449.5MHz, f2 = 450.5MHz)



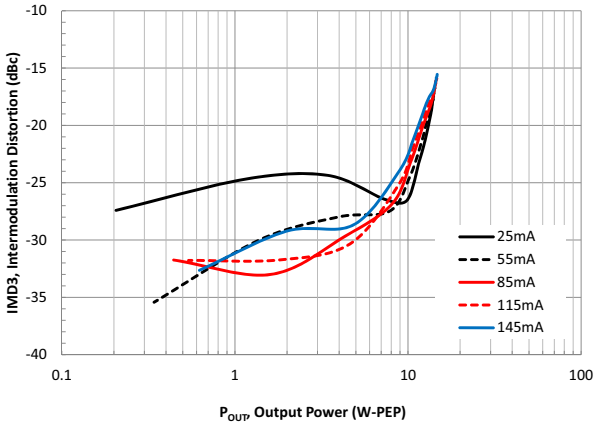
Gain versus Output Power
(2-Tone 1MHz Separation, V_D = 28V, I_{DQ} varied, fc = 450MHz)



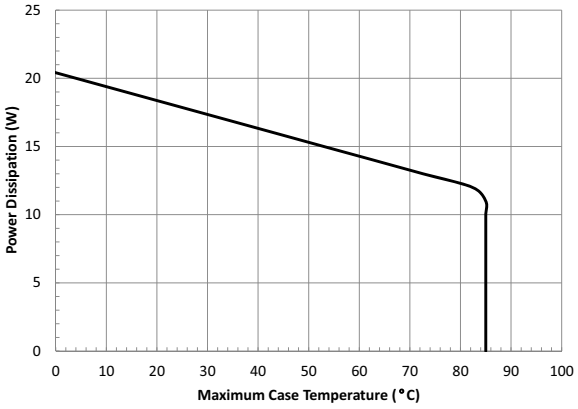
Drain Efficiency versus Output Power
(2-Tone 1MHz Separation, V_D = 28V, I_{DQ} varied, fc = 450MHz)



IMD3 versus Output Power
(2-Tone 1MHz Separation, V_D = 28V, I_{DQ} varied, fc = 450MHz)



Power Dissipation De-rating Curve
(Based on Maximum package temperature and R_{TH})



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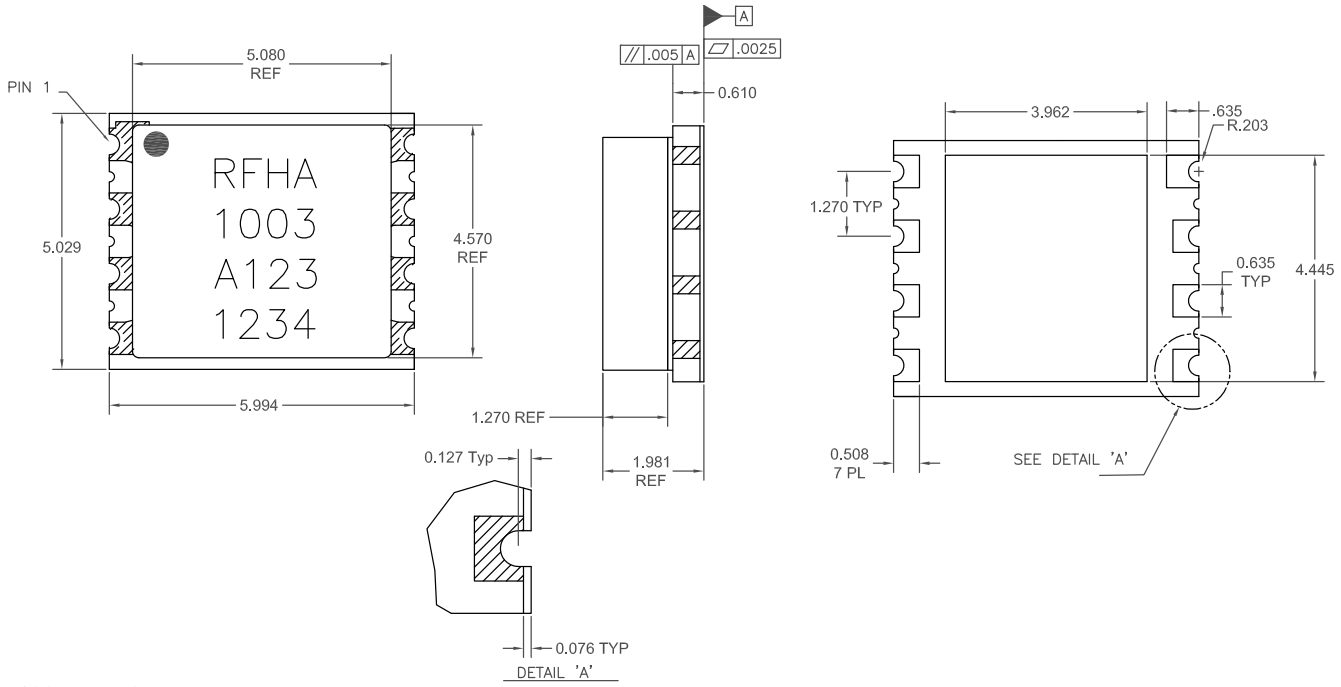
Package Drawing

(All dimensions in mm.)



A123 : Trace Code
1234 : Serial Number
Package Style: Ceramic SO8

Pin Names and Descriptions

Pin	Name	Description
1	VGS	Gate DC Bias pin
2	RF IN	RF Input
3	RF IN	RF Input
4	N/C	No Connect
5	N/C	No Connect
6	RF OUT/VDS	RF Output / Drain DC Bias pin
7	RF OUT/VDS	RF Output / Drain DC Bias pin
8	N/C	No Connect
Pkg Base	GND	Ground

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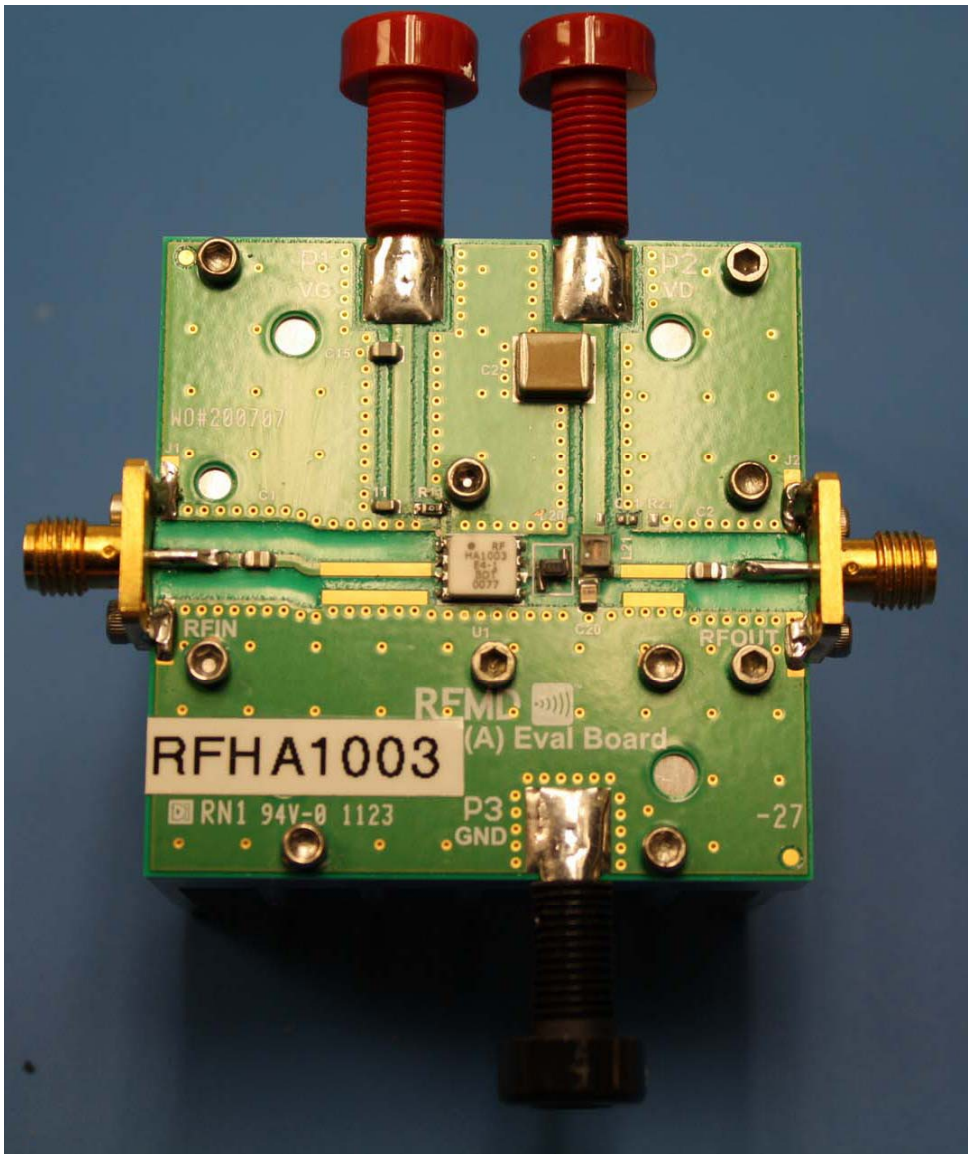
Bias Instruction for RFHA1003 Evaluation Board

ESD Sensitive Material. Please use proper ESD precautions when handling devices of evaluation board. Evaluation board requires additional external fan cooling. Connect all supplies before powering evaluation board.

1. Connect RF cables at RFIN and RFOUT.
2. Connect ground to the ground supply terminal, and ensure that both the VG and VD grounds are also connected to this ground terminal.
3. Apply -5V to VG.
4. Apply 28V to VD.
5. Increase V_G until drain current reaches 55mA or desired bias point.
6. Turn on the RF input.

Typical test data provided is measured to SMA connector reference plane, and include evaluation board / broadband bias network mismatch and losses.



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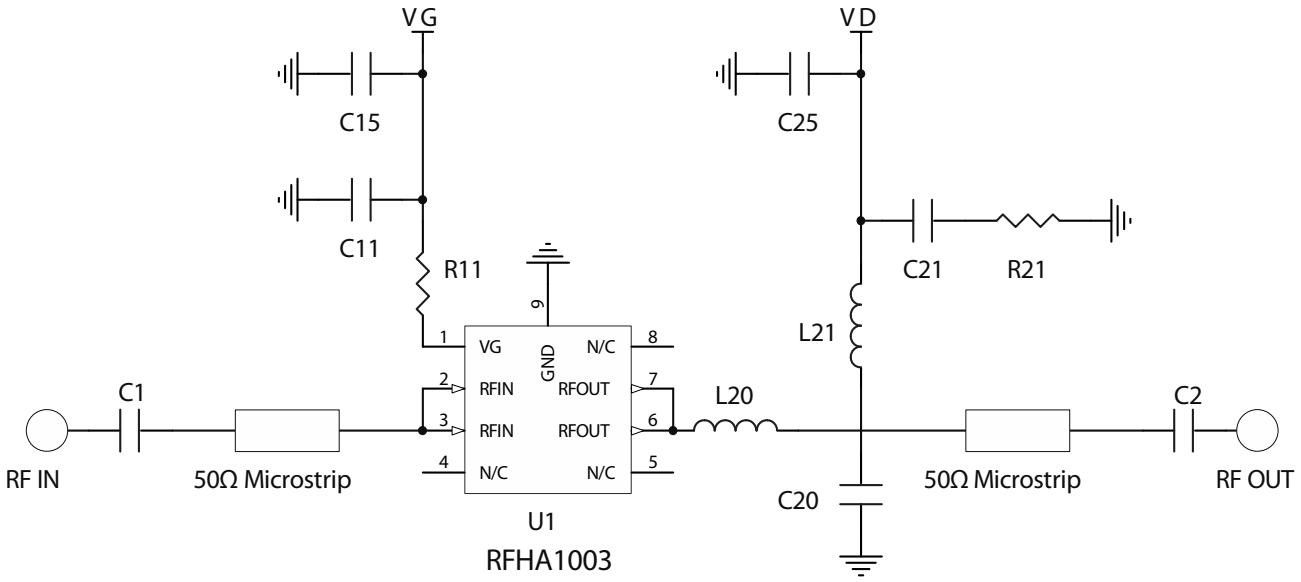
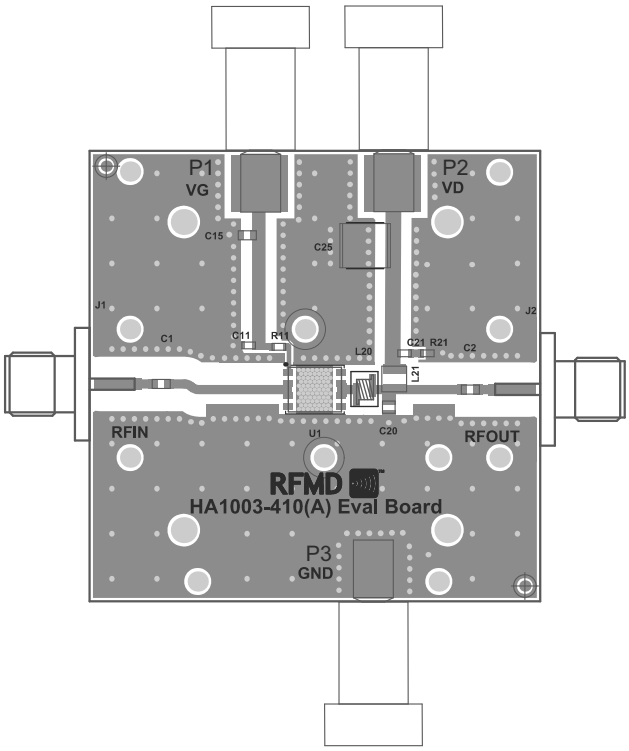
Evaluation Board Schematic



Evaluation Board Bill of Materials (BOM)

Component	Value	Manufacturer	Part Number
C1, C2	2400pF	Dielectric Labs Inc	C08BL242X-5UN-X0
C11	10000pF	Murata Electronics	GRM188R71H103KA01D
C15	10μF	Murata Electronics	GRM21BF51C106ZE15L
C20	0.8pF	ATC	100A0R8BW150XT
C25	4.7μF	Murata Electronics	GRM55ER72A475KA01L
R11	0Ω	Panasonic	ERJ-3GEY0R00V
L20	5.4nH	Coilcraft	0906-5_LB
L21	0.9μH	Coilcraft	1008AF-901XJLC
C21, R21	NOT USED	-	-

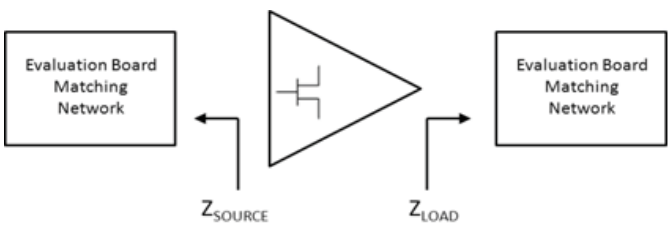
Evaluation Board Layout



Device Impedances

Frequency (MHz)	RFHA1003PCBA-410 (30MHz to 512MHz)	
	Z Source (Ω)	Z Load (Ω)
30	49.84-j1.61	45.86+j11.88
100	50.00-j1.36	49.11+j1.28
150	49.77-j1.68	48.20-j1.43
200	49.58-j2.22	46.77-j3.34
250	49.41-j2.71	44.97-j4.64
300	49.17-j3.06	42.97-j5.24
350	48.77-j3.50	40.74-5.48
400	48.44-j3.95	38.41-j5.24
450	48.07-j4.21	36.28-j4.57
512	47.45-j4.64	33.49-j3.34

NOTE: Device impedances reported are the measured evaluation board impedances chosen for a tradeoff of efficiency and peak power performance across the entire frequency bandwidth.



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Device Handling/Environmental Conditions

RFMD does not recommend operating this device with typical drain voltage applied and the gate pinched off in a high humidity, high temperature environment.

GaN HEMT devices are ESD sensitive materials. Please use proper ESD precautions when handling devices or evaluation boards.

DC Bias

The GaN HEMT device is a depletion mode high electron mobility transistor (HEMT). At zero volts V_{GS} the drain of the device is saturated and uncontrolled drain current will destroy the transistor. The gate voltage must be taken to a potential lower than the source voltage to pinch off the device prior to applying the drain voltage, taking care not to exceed the gate voltage maximum limits. RFMD recommends applying V_{GS} = -5V before applying any V_{DS}.

RF Power transistor performance capabilities are determined by the applied quiescent drain current. This drain current can be adjusted to trade off power, linearity, and efficiency characteristics of the device. The recommended quiescent drain current (I_{DQ}) shown in the RF typical performance table is chosen to best represent the operational characteristics for this device, considering manufacturing variations and expected performance. The user may choose alternate conditions for biasing this device based on performance tradeoffs.

Mounting and Thermal Considerations

The thermal resistance provided as R_{TH} (junction to case) represents only the packaged device thermal characteristics. This is measured using IR microscopy capturing the device under test temperature at the hottest spot of the die. At the same time, the package temperature is measured using a thermocouple touching the backside of the die embedded in the device heat sink but sized to prevent the measurement system from impacting the results. Knowing the dissipated power at the time of the measurement, the thermal resistance is calculated.

In order to achieve the advertised MTTF, proper heat removal must be considered to maintain the junction at or below the maximum of 200°C. Proper thermal design includes consideration of ambient temperature and the thermal resistance from ambient to the back of the package including heat sinking systems and air flow mechanisms. Incorporating the dissipated DC power, it is possible to calculate the junction temperature of the device

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Адрес: 105318, г.Москва, ул.Щербаковская д.3, офис 1107

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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:
moschip.ru
moschip.ru_4
moschip.ru_6
moschip.ru_9